

# **USB HIGH-SIDE POWER SWITCH / LOAD SWITCH**

NO.EA-188-230707

# OUTLINE

The R5524x is a CMOS-based high-side MOSFET switch IC which conforms to the universal serial bus (USB) standard. It can also be used as a load switch IC with protection function. By using an Nch MOSFET with low On-resistance (Typ. 100 m $\Omega$ ) as a switching transistor, the device can provide low dropout voltage. Internally, the device consists of an overcurrent limiting circuit, a thermal shutdown circuit, an undervoltage lockout (UVLO) circuit and a reverse current protection circuit. The device also consists of an internal delay circuit to prevent the output of false flag signals caused by inrush current. To achieve simplification of layout design, the overcurrent detection accuracy has been improved. The R5524x is offered in a 5-pin SOT-23-5 package and a 6-pin DFN(PL)1820-6 package which achieve the smallest possible footprint solution on boards where area is limited.

# **FEATURES**

- N-channel MOS High-Side Switch IC
- Switch ON Resistance ······ Typ. 100 mΩ at 5 V Input
- Current Limit Threshold ..... Min. 650 mA<sup>(1)</sup>, Min. 1.25 A<sup>(2)</sup>
- Overcurrent Limit
   Min. 550 mA
- Flag Delay Time ..... Typ. 20 ms
- Under-voltage Lockout (UVLO) Circuit
- Thermal Shutdown Circuit
- Reverse Current Protection Circuit
- Package ······ SOT-23-5, DFN(PL)1820-6<sup>(3)</sup>

# **APPLICATIONS**

- PCs and PC Peripherals
- Digital Televisions (DTV)
- Set Top Boxes (STB)
- Printers
- PDA
- Game Consoles

<sup>&</sup>lt;sup>(1)</sup> Only for R5524x001A/B, R5524x002A/B

<sup>(2)</sup> Only for R5524N004A

<sup>&</sup>lt;sup>(3)</sup> Only for R5524K001x, R5524K002x

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# SELECTION GUIDE

The overcurrent limit protection type, the current limit threshold and the auto discharge options<sup>(1)</sup> for the ICs are user-selectable options.

## Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R5524N00x*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes
R5524K00x*-TR	DFN(PL)1820-6	5,000 pcs	Yes	Yes

x: Specify the combination of Overcurrent Limit Protection type and Current Limit Threshold.

- 1: Latch-off Type, Current Limit Threshold: Min. 650 mA
- 2: Constant Current Type, Current Limit Threshold: Min. 650 mA
- 4: Cosntant Current Type, Current Limit Threshold: Min. 1.25 A<sup>(2)</sup>

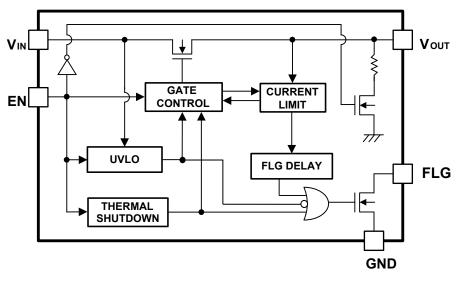
\*: Specify auto-discharge options.

- A: Auto-discharge included
- B: Auto-discharge not included

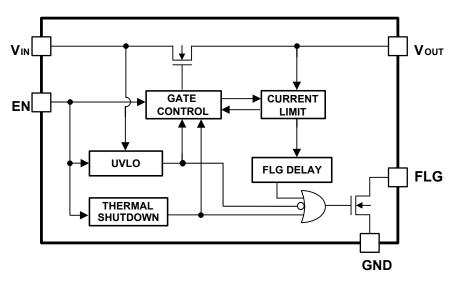
<sup>&</sup>lt;sup>(1)</sup> Auto-discharge function quickly lowers the output voltage to 0 V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.
<sup>(2)</sup> Only for R5524N004A

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# **BLOCK DIAGRAMS**



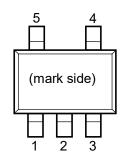


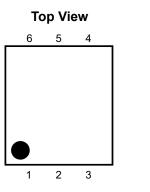


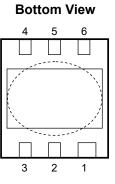


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# **PIN DESCRIPTIONS**







## R5524N (SOT-23-5) Pin Configuration

R5524K (DFN(PL)1820-6) Pin Configuration

#### R5524N Pin Description

Pin No.	Symbol	Description	
1	VIN	Input Pin	
2	GND	Ground Pin	
3	EN	Chip Enable Pin, Active-high	
4	FLG	Flag Pin, Open Drain Output	
5	VOUT	Output Pin	

#### **R5524K Pin Description**

KJJZ4K FIII L				
Pin No.	Symbol	Description		
1	VOUT	Output Pin		
2	NC	No Connection		
3	FLG	Flag Pin, Open Drain Output		
4	EN	Enable Pin, Active-high		
5	GND	Ground Pin		
6	VIN	Input Pin		

The exposed tab is substrate level (GND). It is recommended that the exposed tab be connected to the ground plane on the board or otherwise be left open.

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# **ABSOLUTE MAXIMUM RATINGS**

#### **Absolute Maximum Ratings**

Symbol		Rating	Unit	
VIN	Input Voltage	6.0	V	
VEN	Enable Pin Input Voltage	Enable Pin Input Voltage		V
VFLG	Flag Pin Voltage		-0.3 to 6.0	V
IFLG	Flag Pin Current		14	mA
Vout	Output Pin Voltage		-0.3 to 6.0	V
Іоит	Output Current		Internally Contr	olled
	Dower Discinction <sup>(1)</sup>	SOT-23-5, JEDEC STD.51-7	660	mW
PD	Power Dissipation <sup>(1)</sup>	DFN(PL)1820-6, JEDEC STD.51-7	2200	mW
Tj	Junction Temperature Range		-40 to 125	°C
Tstg	Storage Temperature Range		-55 to 125	°C

## ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

# **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Rating	Unit
V <sub>IN</sub>	Operating Input Voltage	2.7 to 5.5	V
Та	Operating Temperature Range	−40 to 85	°C

## RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>&</sup>lt;sup>(2)</sup> Refer to POWER DISSIPATION for detailed information.

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# **ELECTRICAL CHARACTERISTICS**

The specifications surrounded by  $\square$  are guaranteed by design engineering at  $-40^{\circ}C \le Ta \le 85^{\circ}C$ .

Symbol	Item	Conditions		Min.	Тур.	Max.	Unit
VIN	Input Voltage			2.7		5.5	V
	Supply Current (Active Mode)	Vout = OPEN, E	N = "H", V <sub>IN</sub> = 5 V		110	180	μA
IDD2	Supply Current (Standby Mode)	Vout = OPEN, E	N = "L", V <sub>IN</sub> = 5 V		0.1	1.0	μA
Ron	Switch On Resistance	V <sub>IN</sub> = 5 V, I <sub>OUT</sub> = 9	500 mA		100	150	mΩ
ton	Output Turn-on Delay	$V_{IN} = 5 V, R_L = 60$	) Ω		400		μs
toff	Output Turn-off Delay	V <sub>IN</sub> = 5V, R <sub>L</sub> = 60	Ω		50		μs
V <sub>UVLO</sub>	UVLO Release Voltage	V <sub>IN</sub> Rising		2.3	2.5	2.7	V
V <sub>HYS</sub>	UVLO Hysteresis Range	V <sub>IN</sub> Falling			0.1		V
		R5524x001A/B R5524x002A/B	V <sub>IN</sub> = 5 V	650	800	980	mA
Ітн	Current Limit Threshold		$V_{IN} = 5 V$	1.25	1.55	1.85	
		R5524N004A	V <sub>IN</sub> = 5 V, 0°C ≤ Ta ≤ 70°C	1.2	1.55	1.9	A
I <sub>LIM</sub>	Overcurrent Limit	$V_{IN} = 5 V$ , After 5 ms from when $V_{OUT} = 0 V^{(1)}$		550	650	800	mA
t <sub>FD</sub>	Flag Delay Time <sup>(2)</sup>	$V_{IN} = 5 V$ , From when overcurrent detection until when FLG = "L"		7	20	30	ms
T <sub>TSD</sub>	Thermal Shutdown Temperature	Junction Temperature			135		°C
T <sub>TSR</sub>	Thermal Shutdown Released Temperature	Junction Temper	Junction Temperature		120		°C
I <sub>EN</sub>	Enable Pin Input Current				0.01	1.0	μA
$V_{\text{EN1}}$	Enable Pin Input Voltage 1	VEN Rising	V <sub>EN</sub> Rising			6.0	V
$V_{\text{EN2}}$	Enable Pin Input Voltage 2	V <sub>EN</sub> Falling		-0.3		0.8	V
Ilo	Output Leakage Current				0.1	1.0	μA
$V_{LF}$	Flag "L" Output Voltage	I <sub>SINK</sub> = 1 mA				0.4	V
FOF	Flag Off Current	V <sub>FLG</sub> = 5.5 V			0.01	1.0	μA
I <sub>REV</sub>	Reverse Leakage Current	V <sub>IN</sub> = 0 V, V <sub>OUT</sub> = 5.5 V				50	μA
RLOW	Nch. On-resistance for Auto Discharge (R5524x00xA only)				450		Ω

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj ≈ Ta = 25°C) except Thermal Shutdown Temperature and Thermal Shutdown Released Temperature.

<sup>&</sup>lt;sup>(1)</sup> Refer to "Overcurrent limit Function" in THEORY OF OPERATION for details.

<sup>&</sup>lt;sup>(2)</sup> Flag Delay Time is dependent on Input Voltage.

# THEORY OF OPERATION

## **Overcurrent Limit Function**

The R5524x001A/001B has the built-in latch-off type over-current limit circuit. When the over-current is detected, the protection circuit becomes active and the switch-transistor is turned OFF. The latch function is released if the input voltage value is exceeded in the release threshold of the UVLO circuit value after when it became lower than the detection threshold of the UVLO circuit value; or the EN pin set to the enabling condition again after set to the disabling condition.

If the over current condition occurred when the input voltage value was close to the minimum operating input voltage value. Under this condition, the voltage descends by the parasitic impedance on the power supply side, and it might fall below the detection threshold of the UVLO circuit. In this case, the switch-transistor is turned OFF and because of that the voltage drop of power line's parasitic impedance stops; the latch function is released with the UVLO and it becomes the over current condition again. The switch transistor keeps continual ON and OFF until one of the following is done; increasing the input voltage value; the setting of EN pin is disabling; or reducing the value of load current.

Moreover, the supply-voltage changed by the load-current dramatically changed depends upon the parasitic impedance of the wiring on the load side or the power supply side. Due to this, decreasing the parasitic impedance by the wiring on board is recommended.

The switch transistor of the R5524x001A/001B is turned OFF when the latch-off-function operates under the condition of the load of the constant current as the load device, such as the electronic load and so on, connecting with the V<sub>OUT</sub> pin of the R5524x001A/001B. Because the load device keeps the constant current, the V<sub>OUT</sub> pin voltage may become negative potential. If the V<sub>OUT</sub> pin is exceed the absolute maximum rating may cause the permanent damages to the device, please avoid using in this situation.

The R5524x002A/002B and R5524N004A have the built-in over current protection circuit as the constant current type. It detects as the over-current condition, if the current flows as the ITH defined. Then operating the switch transistor to limit the output current to be the constant current defined by the ILIM.

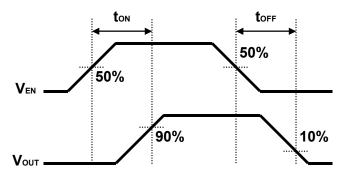
If the condition of the over-current limit caused by the V<sub>OUT</sub> pin clamped to the GND were continued the temperature of the ICs would increase drastically. The switch-transistor is turned OFF if the temperature of the ICs becomes over 135°C (Typ.). And after this, the switch-transistor is turned ON again when the temperature of ICs decreased approximately 15°C. The switch-transistor keeps continual ON and OFF until either the switch is turned OFF or the V<sub>OUT</sub> pin is removed from GND.

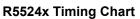
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# **Timing Chart**

## R5524xxxA/B

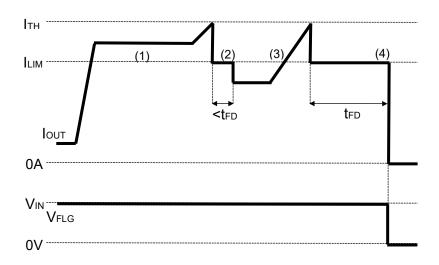
Output On-time and Output Off-time





## R5524x001A/B (Latch-off Type)

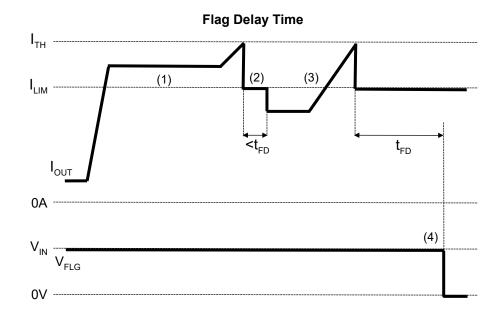
Flag Delay Time



## R5524x001A/001B (Latch-off Type) Timing Chart

- (1) When the  $I_{OUT}$  is  $I_{TH}$  or less, the current is not limited.
- (2) Once the  $I_{\text{OUT}}$  reaches to  $I_{\text{TH}},$  the  $I_{\text{OUT}}$  is limited by  $I_{\text{LIM}}.$
- (3) When the I<sub>OUT</sub> drops to I<sub>LIM</sub> or less within the t<sub>FD</sub> time, the current limit is released. The current is not limited until the I<sub>OUT</sub> exceeds I<sub>TH</sub> again.
- (4) When the  $I_{OUT}$  reaches to  $I_{TH}$  and it is limited by  $I_{LIM}$  for  $t_{FD}$  or more, the switch transistor turns off and  $V_{FLG}$  becomes "Low".

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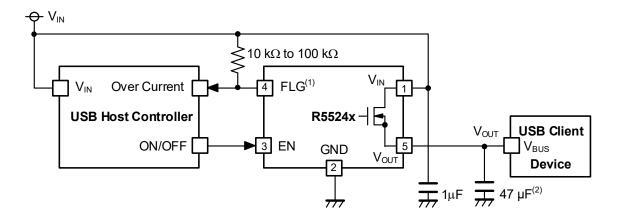
## R5524x002A/B、R5524N0004A (Constant Current Protection Type)

#### R5524x002A/002B and R5524N004A (Constant Current Type) Timing Chart

- (1) When  $I_{OUT}$  is  $I_{TH}$  or less, the current is not limited.
- (2) Once the lout reaches to ITH, the lout is limited by ILIM.
- (3) When the  $I_{OUT}$  drops to  $I_{LIM}$  or less within the  $t_{FD}$  time, the current limit is released. The current is not limited until the  $I_{OUT}$  exceeds  $I_{TH}$  again.
- (4) When the I<sub>OUT</sub> reaches to I<sub>TH</sub> and it is limited by I<sub>LIM</sub> for t<sub>FD</sub> or more, the V<sub>FLG</sub> becomes "Low".

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# **APPLICATION INFORMATION**



### **R5524x Typical Reference Circuit**

## **Precautions for Selecting External Components**

## **Bypass Capacitor**

A  $0.1\mu$ F to  $1\mu$ F bypass capacitor between the V<sub>IN</sub> pin and the GND pin, close to the device, is recommended. This precaution reduces power supply transients that may cause ringing on the input.

## **Pull-up Resistor of FLG Pin**

A 10 k $\Omega$  to 100 k $\Omega$  pull-up resistor is recommended for the FLG pin.

#### R5524x001A/001B

The R5524x001A/001B is equipped with a latch-off function which requires initialization before start-up.

Case 1: Start-up by EN Pin Control EN pin must be enabled with the delay of 10 µs or more against 90% of V<sub>IN</sub> voltage rising edge.

Case 2: Start-up by EN Pin Tied to  $V_{IN}$  Pin Slew rate of  $V_{IN}$  must be 40  $\mu$ s/V or slower.

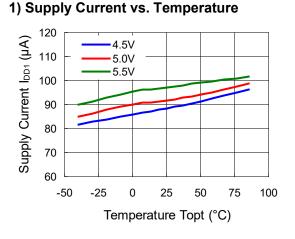
<sup>&</sup>lt;sup>(1)</sup> FLG pin is Nch. Open Drain Output.

<sup>&</sup>lt;sup>(2)</sup> A 47 μF or more output capacitor is recommended. According to a USB standard, a 120 μF or more output capacitor is required.

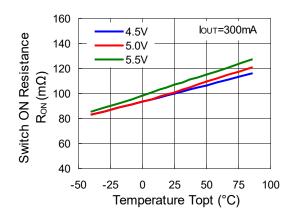
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# **TYPICAL CHARACTERISTICS**

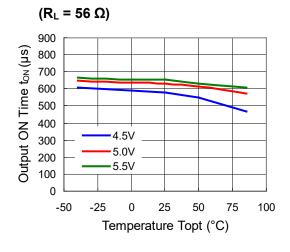
Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.



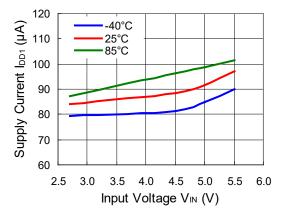
## 3) Switch ON Resistance vs. Temperature



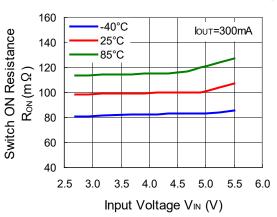
5) Output ON Time vs. Temperature



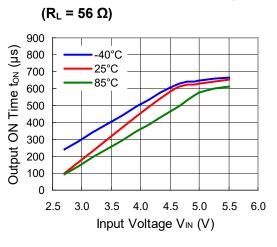
# 2) Supply Current vs. Input Voltage



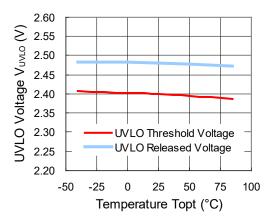
## 4) Switch ON Resistance vs. Input Voltage



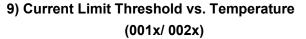
6) Output ON Time vs. Input Voltage

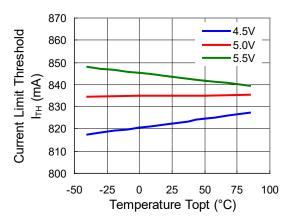


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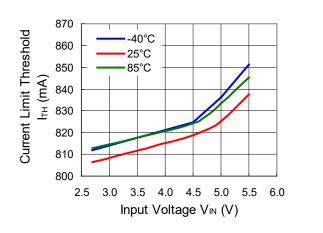


#### 7) UVLO Voltage vs. Temperature

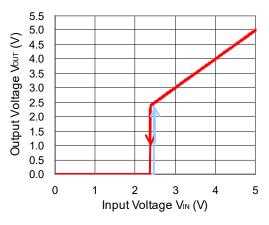




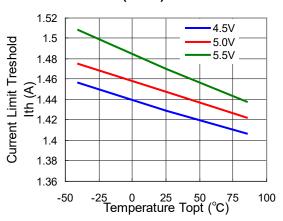
## 11) Current Limit Threshold vs. Input Voltage (001x/ 002x)

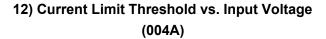


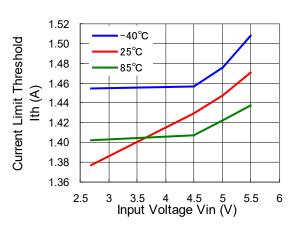
#### 8) Output Voltage vs. Input Voltage



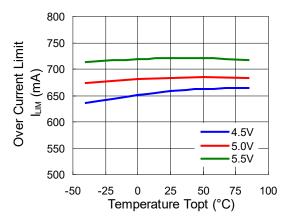
# 10) Current Limit Threshold vs. Temperature (004A)





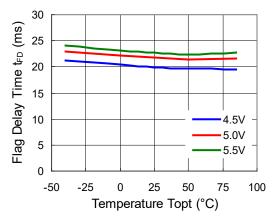


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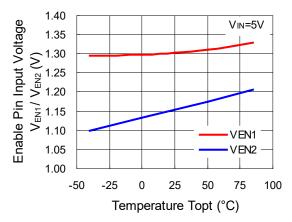


#### 13) Overcurrent Limit vs. Temperature

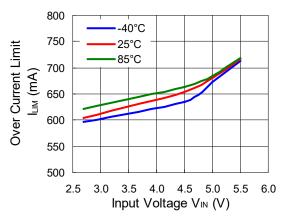




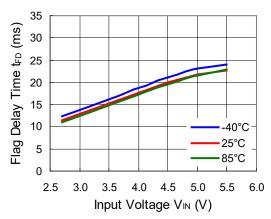
## 17) Enable Input Voltage vs. Temperature



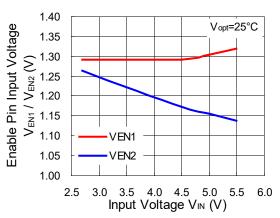
## 14) Overcurrent Limit vs. Input Voltage



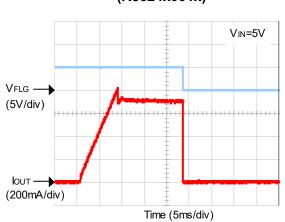
16) Flag Delay Time vs. Input Voltage



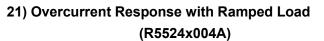


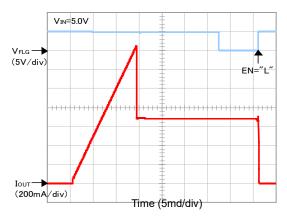


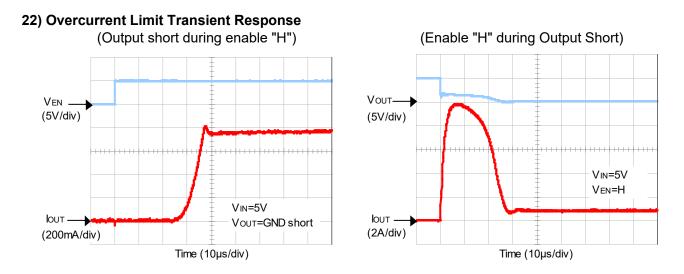
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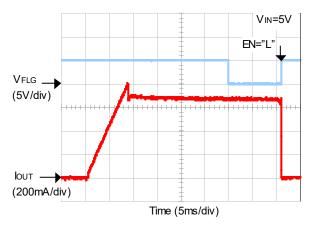
# 19) Overcurrent Response with Ramped Load (R5524x001x)





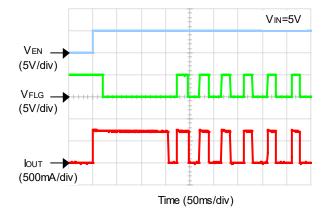


# 20) Overcurrent Response with Ramped Load (R5524x002x)

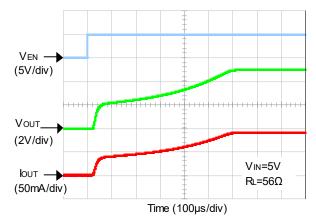


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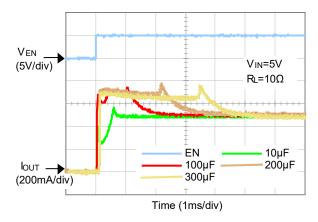
#### 23) Thermal Shutdown Operation



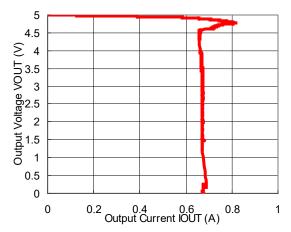
## 25) Output ON Time Response



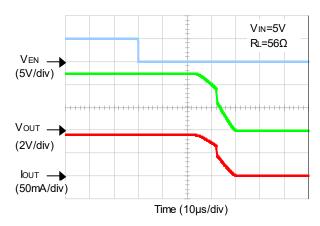




# 24) Output Voltage vs. Output Current







# **POWER DISSIPATION**

# SOT-23-5

PD-SOT-23-5-(85125)-JE-B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

#### **Measurement Conditions**

ltem	Measurement Conditions		
Environment	Mounting on Board (Wind Velocity = 0 m/s)		
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)		
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm		
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square		
Through-holes	φ 0.3 mm × 7 pcs		

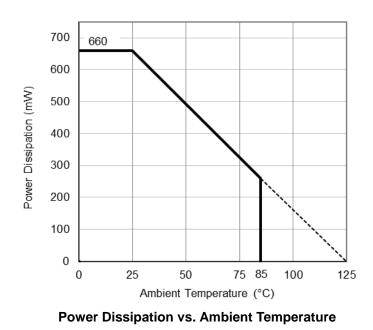
#### **Measurement Result**

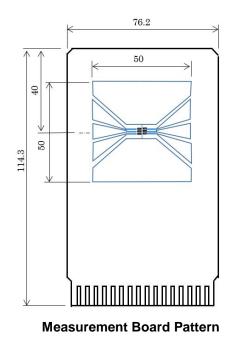
(Ta = 25°C, Tjmax = 125°C)

(		
Measurement Result		
660 mW		
θja = 150°C/W		
ψjt = 51°C/W		

θja: Junction-to-Ambient Thermal Resistance

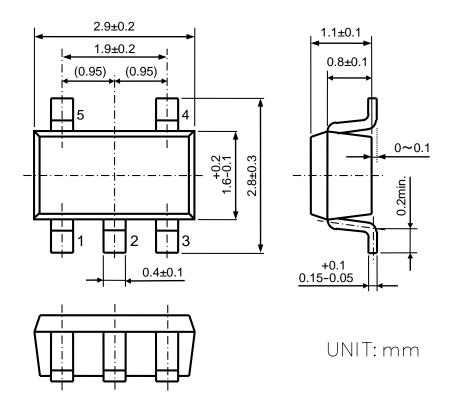
wjt: Junction-to-Top Thermal Characterization Parameter





# SOT-23-5

DM-SOT-23-5-JE-B



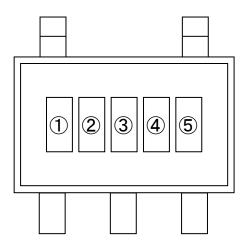


# PART MARKINGS

# R5524N

MK-R5524N-JE-B

①②③: Product Code … Refer to *Part Marking List*④⑤: Lot Number … Alphanumeric Serial Number



R5524N (SOT-23-5) Part Markings

## NOTICE

There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.

## **R5524N Part Marking List**

Product Name	123
R5524N001A	MAA
R5524N002A	M A C
R5524N004A	MAF

Product Name	123
R5524N001B	MAB
R5524N002B	MAD

# **POWER DISSIPATION**

# DFN(PL)1820-6

PD-DFN(PL)1820-6-(85125)-JE-C

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51.

## **Measurement Conditions**

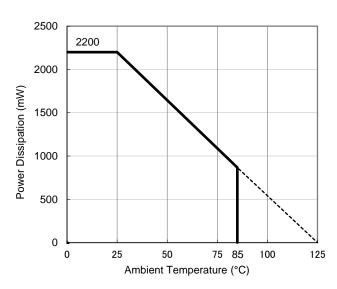
Item	Measurement Conditions	
Environment	Mounting on Board (Wind Velocity = 0 m/s)	
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)	
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm	
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square	
Through-holes	φ 0.2 mm × 36 pcs	

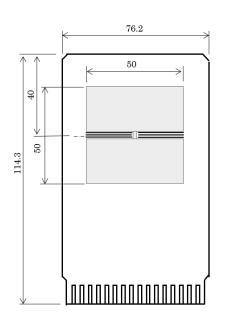
#### **Measurement Result**

(Ta = 25°C, Tjmax = 125°C) Item **Measurement Result** 2200 mW **Power Dissipation**  $\theta$ ja = 45°C/W Thermal Resistance (θja) Thermal Characterization Parameter (wit) ψjt = 18°C/W

θja: Junction-to-Ambient Thermal Resistance

wit: Junction-to-Top Thermal Characterization Parameter





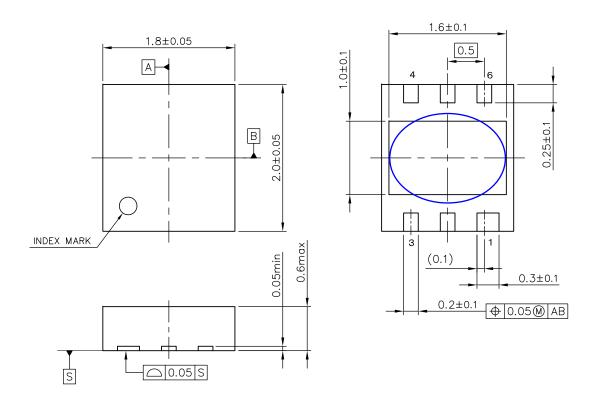
**Power Dissipation vs. Ambient Temperature** 

**Measurement Board Pattern** 

# PACKAGE DIMENSIONS

# DFN(PL)1820-6

DM-DFN(PL)1820-6-JE-B



UNIT: mm

DFN(PL)1820-6 Package Dimensions

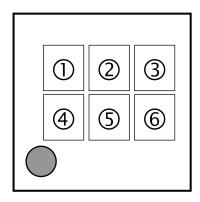
\* The tab on the bottom of the package is substrate level ( $GND/V_{DD}$ ). It is recommended that the tab be connected to the ground plane/the VDD pin on the board, or otherwise be left floating.

# PART MARKINGS

# R5524K

MK-R5524K-JE-A

①②③④: Product Code … Refer to *Part Marking List*⑤⑥: Lot Number … Alphanumeric Serial Number



## R5524K (DFN(PL)1820-6) Part Markings

NOTICE

There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or distributor before attempting to use AOI.

#### **R5524K Part Marking List**

Product Name	0234	Product Name	0234
R5524K001A	E J O O	R5524K001B	E J O 1
R5524K002A	E J O 2	R5524K002B	E J O 3

- 1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to our sales representatives for the latest information thereon.
- 2. The materials in this document may not be copied or otherwise reproduced in whole or in part without the prior written consent of us.
- 3. This product and any technical information relating thereto are subject to complementary export controls (so-called KNOW controls) under the Foreign Exchange and Foreign Trade Law, and related politics ministerial ordinance of the law. (Note that the complementary export controls are inapplicable to any application-specific products, except rockets and pilotless aircraft, that are insusceptible to design or program changes.) Accordingly, when exporting or carrying abroad this product, follow the Foreign Exchange and Foreign Trade Control Law and its related regulations with respect to the complementary export controls.
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- 5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death should first contact us.
  - Aerospace Equipment
  - Equipment Used in the Deep Sea
  - Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
  - Life Maintenance Medical Equipment
  - Fire Alarms / Intruder Detectors
  - Vehicle Control Equipment (automotive, airplane, railroad, ship, etc.)
  - Various Safety Devices
  - Traffic control system
  - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

- 6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
- 8. Quality Warranty
  - 8-1. Quality Warranty Period

In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.

8-2. Quality Warranty Remedies

When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.

- Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
- 8-3. Remedies after Quality Warranty Period

With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.

- 9. Anti-radiation design is not implemented in the products described in this document.
- 10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
- 13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



Nisshinbo Micro Devices Inc.

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